**TENTATIVE** 

All information in this technical data sheet is tentative and subject to change without notice.



# 10.4" XGA

# **TECHNICAL SPECIFICATION**

AA104XF02

COMPANY

RIETARY

# MITSUBISHI ELECTRIC Corp.

Date: Aug.8,'12

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# **1. APPLICATION**

This specification applies to color TFT-LCD module, AA104XF02.

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MITSUBISHI classifies the usage of the TFT-LCD module as follows. Please confirm the usage before using the product.

(1) Standard Usage

Computers, office equipment, factory automation equipment, test and measurement equipment, communications, transportation equipment(automobiles, ships, trains, etc.), provided, however, that operation is not influenced by TFT-LCD directly.

(2) Special Usage

Medical equipment, safety equipment, transportation equipment, provided, however, that TFT-LCD is necessary to its operation.

(3) Specific Usage

Cockpit Equipment, military systems, aerospace equipment, nuclear reactor control systems, life support systems and any other equipment. MITSUBISHI should make a contract that stipulate apportionment of responsibilities between MITSUBISHI and our customer.

The product specified in this document is designed for "Standard Usage" unless otherwise specified in this document. If customers intend to use the product for applications other than those specified for "Standard Usage", they should first contact MITSUBISHI sales representative for it's intended use in writing.

MITSUBISHI has been making continuous effort to improve the reliability of its products. Customers should implement sufficient reliability design of their application equipments such as redundant system design, fail-safe functions, anti-failure features.

MITSUBISHI assumes no responsibility for any damage resulting from the use of the product that does not comply with the instructions and the precautions specified in this document.

Please contact and consult a MITSUBISHI sales representative for any questions regarding this product.

# 2. OVERVIEW

AA104XF02 is 10.4" color TFT-LCD (Thin Film Transistor Liquid Crystal Display) module composed of LCD panel, driver ICs, control circuit, LED driver and backlight unit.

By applying 6 bit or 8 bit digital data,  $1024 \times 768$ , 262k-color or 16.7M-color images are displayed on the 10.4" diagonal screen. Input power voltages are 3.3 V for LCD driving and 12.0 V for backlight unit. The type of data and control signals are digital and transmitted via LVDS interface per Typ. 65 MHz clock cycle.

This product has LED driving circuit inside. The LED driving circuit has PWM light dimming function, which is controlled by PWM.

ITEM	SPECIFICATION
Display Area (mm)	210.4 (H) × 157.8 (V) (10.4-inch diagonal)
Number of Dots	$1024 \times 3 \text{ (H)} \times 768 \text{ (V)}$
Pixel Pitch (mm)	$0.2055 (H) \times 0.2055 (V)$
Color Pixel Arrangement	RGB vertical stripe
Display Mode	Normally white
Number of Color	262k(6 bit/color), 16.7M(8 bit/color)
Luminance (cd/m <sup>2</sup> )	600
Viewing Angle (CR $\ge$ 10)	-80~80°(H), -65~65°(V)
Surface Treatment	Anti-glare and hard-coating 3H
Electrical Interface	LVDS
Viewing Direction	Higher Contrast ratio: 6 o'clock Less gray scale reversal: 12 o'clock
Module Size (mm)	230.0 (W) × 180.2 (H) × 9.5 (D)
Module Mass (g)	465
Backlight Unit	LED, edge-light, Unreplaceable

General specifications are summarized in the following table:

Characteristic value without any note is typical value.

# **3. ABSOLUTE MAXIMUM RATINGS**

ITEM	SYMBOL	MIN.	MAX.	UNIT
Power Supply Voltage for LCD	VCC	-0.3	4.0	V
Logic Input Voltage	VI	-0.3	VCC+0.3	V
Backlight Power Supply Input Voltage	VL	-0.3	14.0	V
Backlight ON-OFF	BLEN	-0.3	14.0	V
Light Dimming Control (PWM) Input Voltage	V pdim	-0.3	14.0	V
Operation Temperature (Panel) Note 1,2)	Top(Panel)	-30	80	°C
Operation Temperature (Ambient) Note 2)	Top(Ambient)	-30	80	°C
Storage Temperature Note 2)	$\mathrm{T}_{\mathrm{stg}}$	-30	80	°C

[Note]

1) Measured at the center of active area and at the center of panel back surface

2) Top,Tstg  $\leq 40^{\circ}$ C : 90%RH max. without condensation

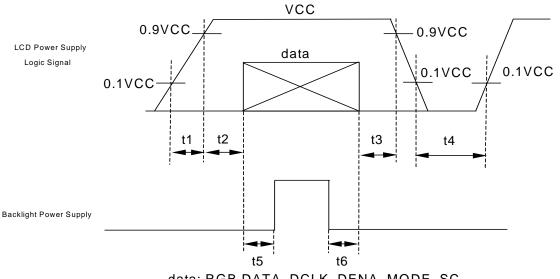
Top,Tstg > 40°C : Absolute humidity shall be less than the value of 90%RH at 40°C without condensation.

# **4. ELECTRICAL CHARACTERISTICS**

1) TFT-LCDAmbient temperature: Ta = 25°C							
ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT	Remarks	
Power Supply Voltages	VCC	3.0	3.3	3.6	V	*1)	
Power Supply Currents	ICC		310	490	mA	*2)	
Permissive Input Ripple Voltage		VRP			100	mVp-p	VCC = +3.3 V
Logia Input Valtaga	High	VIH	$0.8 \times VCC$		VCC	V	MODE, SC
Logic Input Voltage	Low	VIL	0		0.2×VCC	V	MODE, SC

\*1) Power and signals sequence:

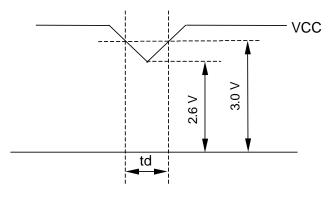
$0.1 \text{ ms} \le t1 \le 10 \text{ ms}$	$200 \text{ms} \leq t4$
$0 < t2 \le 50 ms$	$200ms \leq t5$
$0 < t3 \le 50 ms$	$0 \le t6$



VCC-dip conditions:

- 1) When 2.6 V  $\leq$  VCC < 3.0 V, td  $\leq$  10 ms
- 2) When VCC < 2.6 V

VCC-dip conditions should also follow the power and signals sequence.



\*2) VCC = +3.3 V ,  $\rm f_{H}$  = 48.4 kHz,  $\rm f_{V}$  = 60 Hz,  $\rm f_{CLK}$  = 65 MHz

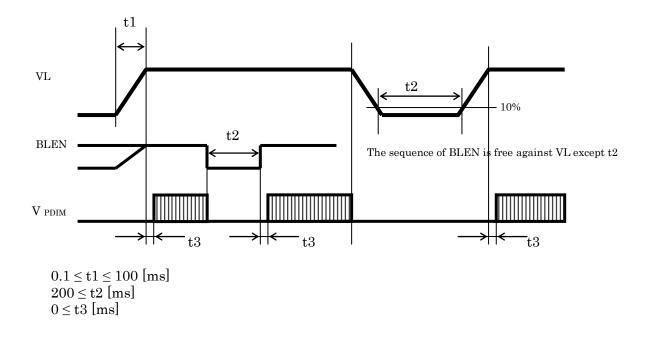
Display image at typical power supply current value is 256-gray-bar pattern (8 bit), 768 line mode.

Parameter	Fuse Type Name	Supplier	Remark
VCC	FCC16162AB	Kamaya Electric Co., Ltd.	*)
(t) (701	1 . 1 111	1 1 1 1	<b>a</b> .

\*) The power supply capacity should be designed to be more than the fusing current.

2) Backlight Ta=25°C							Ta=25°C
ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT	Remarks	
Power Supply Input Vo	oltage	VL	10.8	12.0	13.2	V	*1)
Power Supply Input C	urrent	IL		350	430	mA	Dimming=100% VL=12.0V
Power Supply Input Cu (Rush Current)	ırrent	ILR			(0.9)	А	*2), VL=12.0V
Backlight ON-OFF	High	BLEN	2.5		VL	V	*1), ON
Dacklight ON OFF	Low	DLEIN	0		0.4	V	*1), OFF
Light Dimming Control (PWM) Input	High	V PDIM	2.5		5.5	V	ON
Voltage	Low	V PDIM	0		0.4	V	OFF
PWM frequency		f pdim	100	500	1000	Hz	*3)
Dimming Ratio		DR	5		100	%	*3)
LED Life Time		LT	80,000	100,000		h	*4), *5)

\*1) Power and signals sequence:



- \*2) These data are for reference only. Power Supply Input Current (Rush Current) is influenced by power supply characteristics. (output impedance in particular) Therefore please evaluate LCD in advance.
- \*3) lower frequency causes the flicker or the image breaking of motion picture. Depending on the PDIM signal integrity (jitter etc.), the flicker may be visible. Please evaluate in advance.
- \*4) LED life time is defined as the time when the brightness becomes 50% of the initial value.
- \*5) The life time of the backlight depends on the ambient temperature. The life time will decrease under low/high temperature.

\*6) Fuse

Parameter	Fuse Type Name	Supplier	Remark
VL	FCC16162AB	Kamaya Electric Co., Ltd.	*)

\*) The power supply capacity should be designed to be more than the fusing current.

# **5. INTERFACE PIN CONNECTION**

(1) CN 1 (Interface Signal)

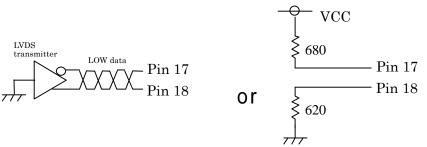
Used connector: 20186-020E-11F (I-PEX) or FI-SEB20P-HFE (JAE) Corresponding connector: 20197-\*20U-F (I-PEX) or FI-S20S[for discrete Wire],

	F1-SE20ME[for FPC] (JAE)							
Pin	Symbol	Function (ISP 6 bit	Function (ISP 8 bit					
No.	Symbol	6 bit input	6 bit input 8 bit input					
1	VCC	+3.3 V Pov	wer supply	$\leftarrow$				
2	VCC	+3.3 V Pov	wer supply	$\leftarrow$				
3	GND	Gì	ND	$\leftarrow$				
4	GND	Gl	ND	$\leftarrow$				
5	Link 0–	R0, R1, R2, R3, R4, R5, G0	R2, R3, R4, R5, R6, R7, G2	R0, R1, R2, R3, R4, R5, G0				
6	Link 0+	R0, R1, R2, R3, R4, R5, G0	R2, R3, R4, R5, R6, R7, G2	R0, R1, R2, R3, R4, R5, G0				
7	GND	Gl	ND	$\leftarrow$				
8	Link 1–	G1, G2, G3, G4, G5, B0, B1	G3, G4, G5, G6, G7, B2, B3	G1, G2, G3, G4, G5, B0, B1				
9	Link 1+	G1, G2, G3, G4, G5, B0, B1	G3, G4, G5, G6, G7, B2, B3	G1, G2, G3, G4, G5, B0, B1				
10	GND	Gl	ND	$\leftarrow$				
11	Link 2–	B2, B3, B4, B5, DENA	B4, B5, B6, B7, DENA	B2, B3, B4, B5, DENA				
12	Link 2+	B2, B3, B4, B5, DENA	B4, B5, B6, B7, DENA	B2, B3, B4, B5, DENA				
13	GND	Gl	ND	←				
14	CLKIN-	Clo	ck –	←				
15	CLKIN+	Clo	ck +	$\leftarrow$				
16	GND	Gl	ND	←				
17	Link3–	See: *2)	R0, R1, G0, G1, B0, B1	R6, R7, G6, G7, B6, B7				
18	Link3+	See: *2)	R0, R1, G0, G1, B0, B1	R6, R7, G6, G7, B6, B7				
19	MODE	Low=ISP 6 bit c	High=ISP 8 bit compatibility mode					
20	SC	Scan direction control. ( Low	v : Normal , High : Reverse )	$\leftarrow$				

FI-SE20ME[for FPC] (JAE)

\*1) Metal frame is connected to signal GND.

\*2) Recommended wiring of Pin 17,18 (6 bit input)



(2) CN 2 (Backlight)

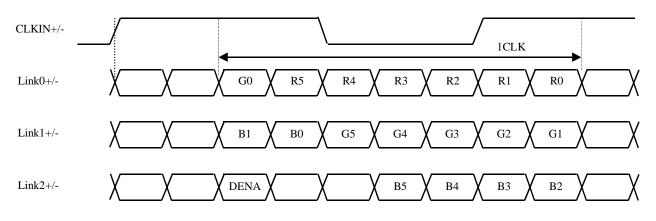
Backlight-side connector: FI-S6P-HFE (JAE) Corresponding connector: FI-S6S (JAE)

Pin No.	Symbol	Function			
1	VL	Power Supply Input Voltage			
2	VL	Power Supply Input Voltage			
3	GND	GND			
4	GND	GND			
5	BLEN	Backlight ON-OFF (High: ON, Low: OFF)			
6	V pdim	Light Dimming Control (PWM) Input Voltage (High active)			

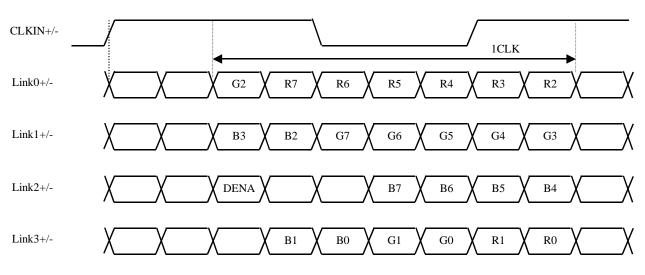
\*1) GND is connected GND (of CN1) and the LCD frame internally.\*2) BLEN is NOT designed for dimming.

#### (3) ISP data mapping

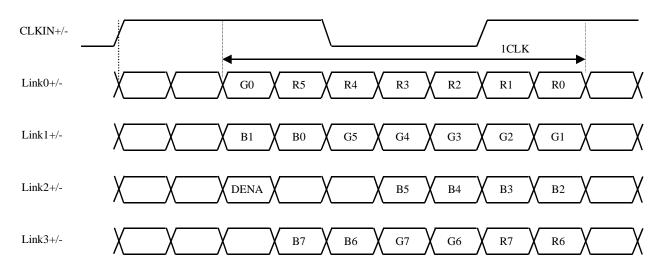
a. ISP 6 bit compatibility mode(6 bit input)



#### b. ISP 6 bit compatibility mode(8 bit input)



c. ISP 8 bit compatibility mode



# 6. INTERFACE TIMING

LVDS transmitter input signal

# (1) Timing Specifications

ITEM		SYMBOL	MIN.	TYP.	MAX.	UNIT	
DOLU	Frequency		fclk	50	65	80	MHz
DCLK	Period		tclk	12.5	15.4	20	ns
		Active Time	$\mathrm{t}_{\mathrm{HA}}$	1024	1024	1024	$t_{\rm CLK}$
	Horizontal	Blanking Time	$t_{ m HB}$	30	320		$t_{\rm CLK}$
	Horizontai	Frequency	$\mathbf{f}_{\mathrm{H}}$	42.4	48.4	60	kHz
DENIA		Period	$t_{ m H}$	16.6	20.7	23.6	$\mu s$
DENA		Active Time	$t_{VA}$	768	768	768	$\mathrm{t}_{\mathrm{H}}$
	Vertical	Blanking Time	$t_{VB}$	3	38		$\mathrm{t}_{\mathrm{H}}$
	vertical	Frequency	$\mathbf{f}_{\mathrm{V}}$	55	60	75	Hz
		Period	tv	13.3	16.7	18.2	ms

[Note]

1) DENA (Data Enable) should always be positive polarity as shown in the timing specification.

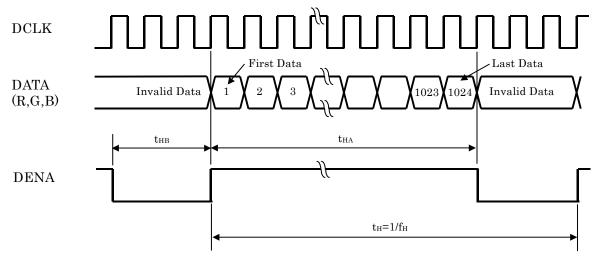
2) DCLK should appear during all invalid period.

3) LVDS timing follows the timing specifications of LVDS receiver IC: THC63LVDF84B(Thine).

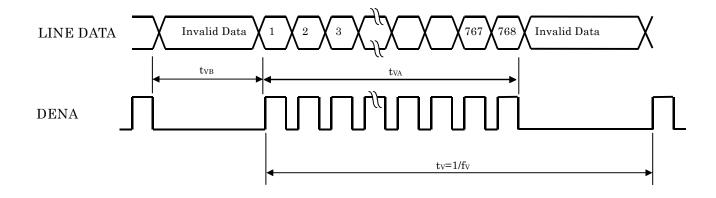
4) In case of blanking time fluctuation, please use following.  $t_{\rm VBn}$  >  $t_{\rm VBn^{-1}}$  – 3(t\_H)

# (2) Timing Chart

# a. Horizontal Timing Chart



# b. Vertical Timing Chart



### (3) Color Data Assignment

### <u>a. 6 bit input</u>

<u>a. 6 Dit i</u>		INPUT DATA R DATA G DATA B DATA																	
		R DATA								B D	ATA		-						
COLOR		R5	<b>R</b> 4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	B3	B2	B1	B0
							LSB	MSB					LSB	MSB					LSB
	BLACK	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED(63)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	GREEN(63)	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
BASIC	BLUE(63)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
COLOR	CYAN	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	MAGENTA	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	YELLOW	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	WHITE	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	RED(1)	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	RED(2)	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0
RED																-			
	RED(62)	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED(63)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	GREEN(1)	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
	GREEN(2)	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
GREEN							_												
	GREEN(62)	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0	0
	GREEN(63)	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	BLUE(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	BLUE(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
BLUE																-			
												-				-			
	BLUE(62)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0
	BLUE(63)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1

[Note]

1) Definition of gray scale

Color(n) - n indicates gray scale level.

Higher n means brighter level.

2) Data

1:High, 0: Low

b. 8 bit input

										-		INI	PUT	' DA	TA			-							
C	R DATA					G DATA								B DATA											
COLOR		R7	R6	R5	R4	R3	R2	$\mathbf{R1}$	R0	G7	G6	G5	$\mathbf{G4}$	G3	G2	G1	G0	B7	B6	B5	B4	B3	B2	B1	B0
		MSB							LSB	MSB							LSB	MSB							LSB
	BLACK	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED(255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
BASIC	GREEN(255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
COLOR	BLUE(255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	CYAN	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	MAGENTA	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	YELLOW	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	WHITE	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	RED(1)	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED(2)	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RED																									
							-																		
	RED(255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	GREEN(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
	GREEN(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
GREEN																									
	GREEN(255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	BLUE(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	BLUE(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
BLUE																									
	BLUE(255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1

[Note]

1) Definition of gray scale

Color (n) --- n indicates gray scale level.

Higher n means brighter level.

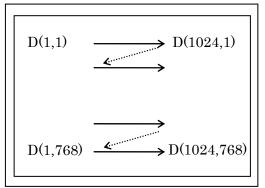
# 2) Data

1:High, 0: Low

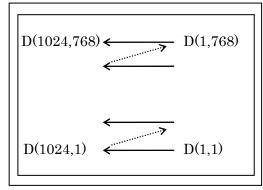
#### (4) Display Position and Scan Direction

D(X,Y) shows the data number of input signal.

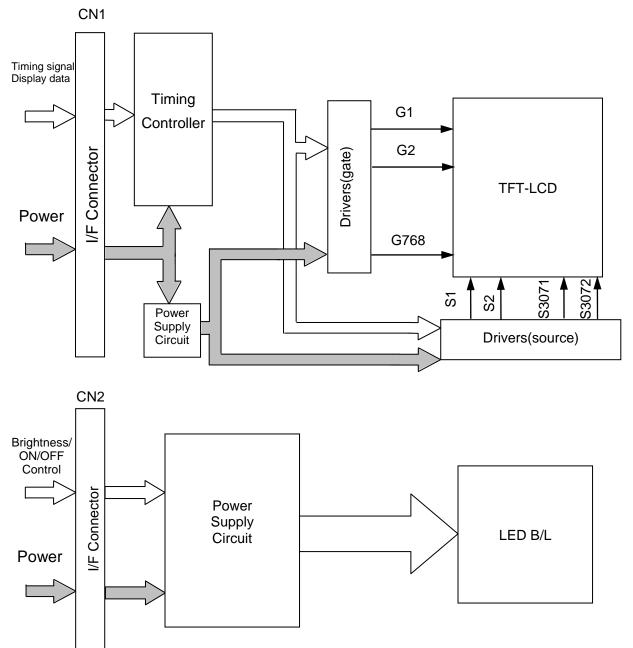






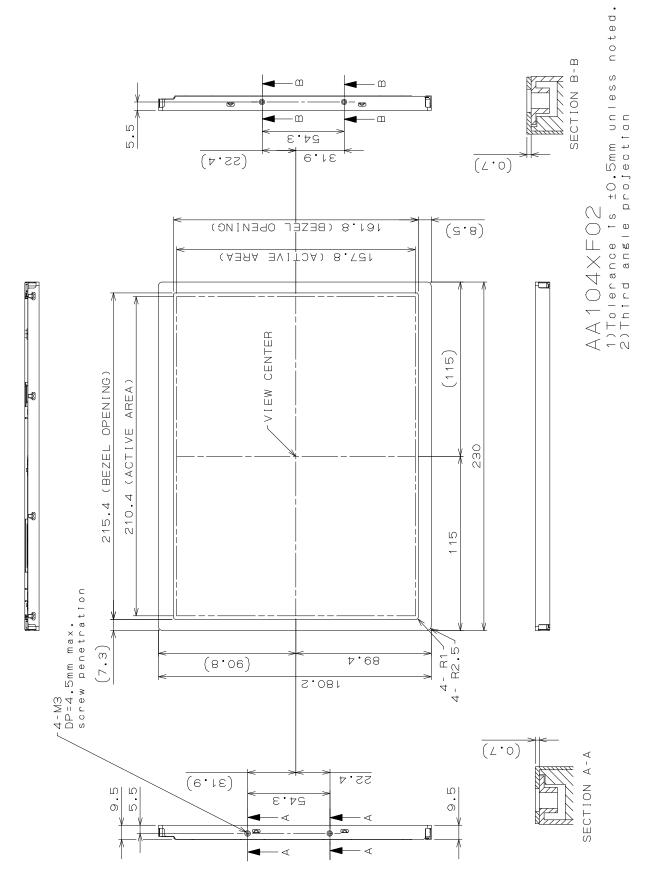


# 7. BLOCK DIAGRAM

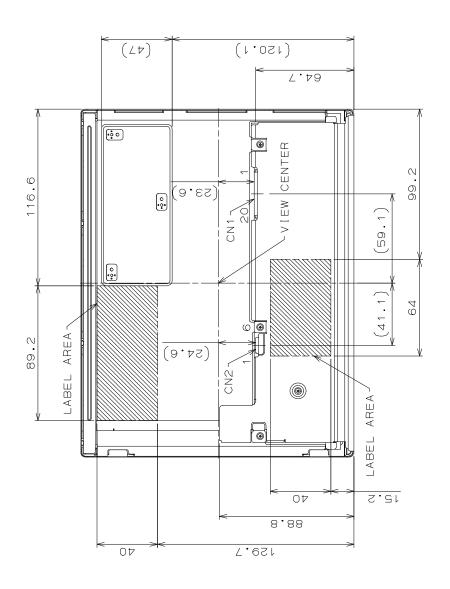


# 8. MECHANICAL SPECIFICATIONS

(1) Front Side



(Unit:mm)



AA104×F02 1)Tolerance is ±0.5mm unless noted. 2)Third angle projection

> (uu:20186-020E-11F (I-PEX) or FI-SEB20P-HFE (JAE) cN2:FI-S6P-HFE (JAE) (uu:mu

<b>9. OPTICAL CHARACTERISTICS</b> Ta=25°C, VCC=3.3V, VL = 12.0V,Input Signals: Typ. values shown in Section 6									
								in Section 6	
ITE	M	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT	Remarks	
Contrast Rat	io	CR	$\theta_{V}=0^{\circ}, \theta_{H}=0^{\circ}$	450	700			*1)*2)*5)	
Luminance		Lw	$\theta_{V}=0^{\circ}, \theta_{H}=0^{\circ}$	480	600		cd/m <sup>2</sup>	*1)*5)	
Luminance U	Jniformity	ΔLw	$\theta_{V}=0^{\circ}, \theta_{H}=0^{\circ}$			30	%	*1)*3)*5)	
Deemonge Tim		tr	$\theta_{V}=0^{\circ}, \theta_{H}=0^{\circ}$		4		ms	*1)*4)*5)	
Response Time		tf	$\theta_{V}=0^{\circ}, \theta_{H}=0^{\circ}$		12		ms	*1)*4)*5)	
Viewing	Horizontal	$\theta_{\rm H}$	CD > 10	$-65 \sim 65$	-80~80		0	*1)*5)	
Angle	Angle Vertical		$CR \ge 10$	$-50 \sim 50$	$-65 \sim 65$		0	*1)*5)	
Image sticking		tis	2 h			2	s	*6)	
	Red	Rx		0.522	0.562	0.602			
		Ry		0.306	0.346	0.386			
	Green	Gx		0.305	0.345	0.385			
Color		Gy		0.495	0.535	0.575			
Coordinates	Blue	Bx	$\theta_{\rm V}=0^{\circ}, \theta_{\rm H}=0^{\circ}$	0.113	0.153	0.193		*1)*5)	
		By		0.096	0.136	0.176			
	White	Wx		0.273	0.313	0.353			
		Wy		0.289	0.329	0.369			

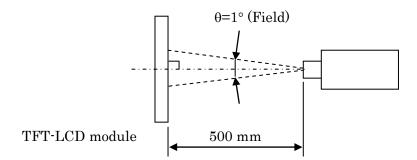
# 9. OPTICAL CHARACTERISTICS

[Note]

These items are measured using EZContrast (ELDIM) for viewing angle and CS2000 (Minolta) or equivalent equipment for others under the dark room condition (no ambient light) after more than 30 minutes from turning on the backlight unless noted.

Condition:  $V_{PDIM} = 2.5 V \sim 5.5 V (DUTY = 100\%)$ 

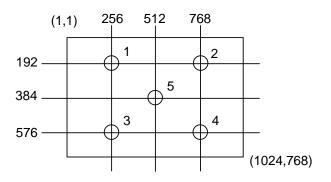
Measurement method for luminance and color coordinates is as follows.



The luminance is measured according to FLAT PANEL DISPLAY MEASUREMENTS STANDARD (VESA Standard).

#### \*1) Measurement Point

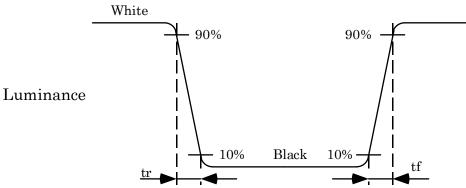
Contrast Ratio, Luminance, Response Time, Viewing Angle, Color Coordinates: Display Center Luminance Uniformity: point  $1\sim5$  shown in a figure below



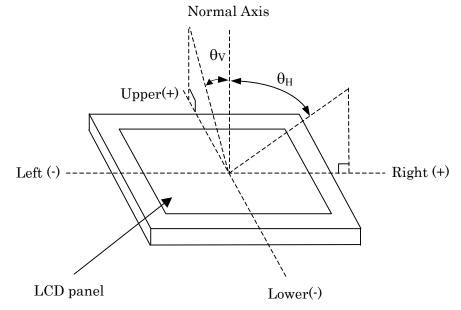
\*2) Definition of Contrast Ratio

CR= Luminance with all white pixels / Luminance with all black pixels

- \*3) Definition of Luminance Uniformity  $\Delta Lw=[Lw(MAX)/Lw(MIN)-1] \times 100$
- \*4) Definition of Response Time

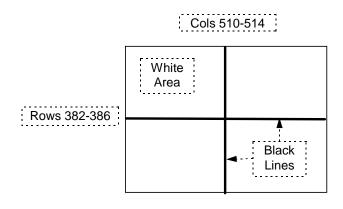


\*5) Definition of Viewing Angle ( $\theta_V$ ,  $\theta_H$ )



# \*6) Image sticking:

Continuously display the test pattern shown in the figure below for two-hours. Then display a completely white screen. The previous image shall not persist more than two seconds at 25°C.



TEST PATTERN FOR IMAGE STICKING TEST

# **10. RELIABILITY TEST CONDITION**

U 1	Temperature and Humidity									
	ITEM	CONDITIONS								
Ē	HIGH TEMPERATURE HIGH HUMIDITY OPERATION	40°C, 90%RH, 240 h (No condensation)								
	HIGH TEMPERATURE OPERATION	80°C, 240 h								
	LOW TEMPERATURE OPERATION	–30°C, 240 h								
	HIGH TEMPERATURE STORAGE	80°C, 240 h								
	LOW TEMPERATURE STORAGE	–30°C, 240 h								
	THERMAL SHOCK	−30°C (1h) ~ 80°C(1h), 100 cycles								

(1) Temperature and Humidity

#### (2) Shock & Vibration

ITEM	CONDITIONS							
	Shock level: 1470 m/s <sup>2</sup> (150G)							
SHOCK	Waveform: half sinusoidal wave, 2 ms							
(NON-OPERATION)	Number of shocks: one shock input in each direction of three mutually							
	perpendicular axes for a total of six shock inputs							
VIBRATION (NON-OPERATION)	Vibration level: 9.8 m/s <sup>2</sup> (1.0G) Waveform: sinusoidal Frequency range: 5 to 500 Hz Frequency sweep rate: 0.5 octave /min Duration: one sweep from 5 to 500 Hz in each of three mutually							
	perpendicular axis(each x,y,z axis: 1 hour, total 3 hours)							

### (3) ESD Test

ITEM	CONDITIONS
CONTACT DISCHARGE (OPERATION)	150pF, 330 $\Omega$ , ±8kV, 10 times at 1 sec interval
SIGNAL PIN DISCHARGE (NON-OPERATION)	200pF, 0 $\Omega$ , ±200V, 10 times at 1 sec interval

# (4) Judgment standard

The judgment of the above tests should be made as follow:

- Pass: Normal display image, no damage of the display function. (ex. no line defect) Partial transformation of the module parts should be ignored.
- Fail: No display image, damage of the display function. (ex. line defect)

# **11. OTHER FEATURE**

This LCD module complies with  ${\rm RoHS}^{\star)}$  directive.

\*) RoHS: Restriction of the use of certain hazardous substances in electrical and electronic equipment

UL1950 certified (UL File# E158720)

# **12. HANDLING PRECAUTIONS FOR TFT-LCD MODULE**

Please pay attention to the followings in handling TFT-LCD products;

#### (1) ASSEMBLY PRECAUTION

- a. Please mount the LCD module by using mounting hole with a screw clamping torque less than
   0.5 Nm. Please do not bend or wrench the LCD module in assembling. Please do not drop, bend
   or twist the LCD module in handling.
- b. Please design display housing in accordance with the following guide lines.
  - (a) Housing case must be designed carefully so as not to put stress on LCD and not to wrench module. If customer uses compression mounting, please evaluate housing case with LCD carefully to avoid image quality issue caused by mechanical stress.
  - (b) Under high temperature environment, performance and life time of LED may heavily shorten. When you design with our LCD product, please consider radiating heat and ventilation for good heat management.
  - (c) Keep sufficient clearance between LCD module back surface and housing when the LCD module is mounted. Approximately 1.0mm of the clearance in the design is recommended taking into account the tolerance of LCD module thickness and mounting structure height on the housing.
  - (d) When some parts, such as, FPC cable and ferrite plate, are installed underneath the LCD module, still sufficient clearance is required, such as 0.5mm. This clearance is, especially, to be reconsidered when the additional parts are implemented for EMI countermeasure.
  - (e) Keep sufficient clearance between LCD module and the others parts, such as inverter and speaker so as not to interfere the LCD module. Approximately 1.0 mm of the clearance in the design is recommended.
  - (f) To avoid local elevation/decrease of temperature, considering location of heating element, heat release, thermal design should be done.
- c. Please do not push or scratch LCD panel surface with anything hard. And do not soil LCD panel surface by touching with bare hands. (Polarizer film, surface of LCD panel is easy to be flawed.)
- d. Please wipe off LCD panel surface with absorbent cotton or soft cloth in case of it being soiled.
- e. Please wipe off drops of adhesives like saliva and water on LCD panel surface immediately. They might damage to cause panel surface variation and color change.
- f. Please do not take a LCD module to pieces and reconstruct it. Resolving and reconstructing modules may cause them not to work well.
- g. Please do not touch metal frames with bare hands and soiled gloves. A color change of the metal frames can happen during a long preservation of soiled LCD modules.
- h. Please handle metal frame carefully because edge of metal frame is very sharp.
- i. Please connect the metal frame of LCD module to GND in order to minimize the effect of external noise and EMI.

j. Be sure to connect the cables and the connecters correctly.

#### (2) OPERATING PRECAUTIONS

- a. Please be sure to turn off the power supply before connecting and disconnecting signal input cable.
- b. Please do not change variable resistance settings in LCD module. They are adjusted to the most suitable value. If they are changed, it might happen LCD does not satisfy the characteristics specification.
- c. The interface signal speed is very high. Please pay attention to transmission line design and other high speed signal precautions to satisfy signal specification.
- d. Condensation might happen on the surface and inside of LCD module in case of sudden change of ambient temperature. Please take care so as not to cause any damage mentioned on (1)-d.
- e. Please pay attention not to display the same pattern for very long time. Image sticking might happen on LCD. Although image sticking may disappear as the operation time proceeds, screen saver function is recommended not to cause image sticking.
- f. Please obey the same safe instructions as ones being prepared for ordinary electronic products.

### (3) PRECAUTIONS WITH ELECTROSTATICS

- a. This LCD module use CMOS-IC on circuit board and TFT-LCD panel, and so it is easy to be affected by electrostatics. Please be careful with electrostatics by the way of your body connecting to the ground and so on.
- b. Please remove protection film very slowly from the surface of LCD module to prevent from electrostatics occurrence.

#### (4) STORAGE PRECAUTIONS

LCD should be stored in the room temperature environment with normal humidity. The LCD inventory should be processed by first-in first-out method.

### (5) SAFETY PRECAUTIONS

- a. When you waste damaged or unnecessary LCDs, it is recommended to crush LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- b. If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

# (6) OTHERS

- a. A strong incident light into LCD panel may cause deterioration to polarizer film, color filter, and other materials, which will degrade the quality of display characteristics. Please do not expose LCD module under strong Ultraviolet rays for a long time.
- b. Please pay attention to a panel side of LCD module not to contact with other materials in preserving it alone.
- c. For the packaging box handling, please see and obey with the packaging specification datasheet.